

# MBR2020FCT - MBR20100FCT

### 20A DUAL SCHOTTKY BARRIER RECTIFIER

### **Features**

- Power Schottky Barrier Chip
- Guard Ring for Transient Protection
- Low Forward Voltage Drop
- Low Power Loss, High Efficiency
- High Surge Current Capability
- Epoxy Meets UL 94V-0 Classification
- Ideally Suited for Use in High Frequency SMPS, Inverters and As Free Wheeling Diodes

### **Mechanical Data**

Case: ITO-220, Full Molded Plastic
Terminals: Plated Leads Solderable per

MIL-STD-202, Method 208 Polarity: See Diagram

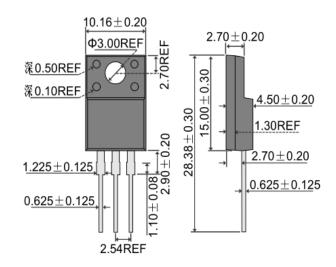
Weight: 1.9 grams (approx.)

Mounting Position: Any

Mounting Torque: 0.6 N.m Max.

Lead Free: For RoHS / Lead Free Version

# **ITO-220AB**





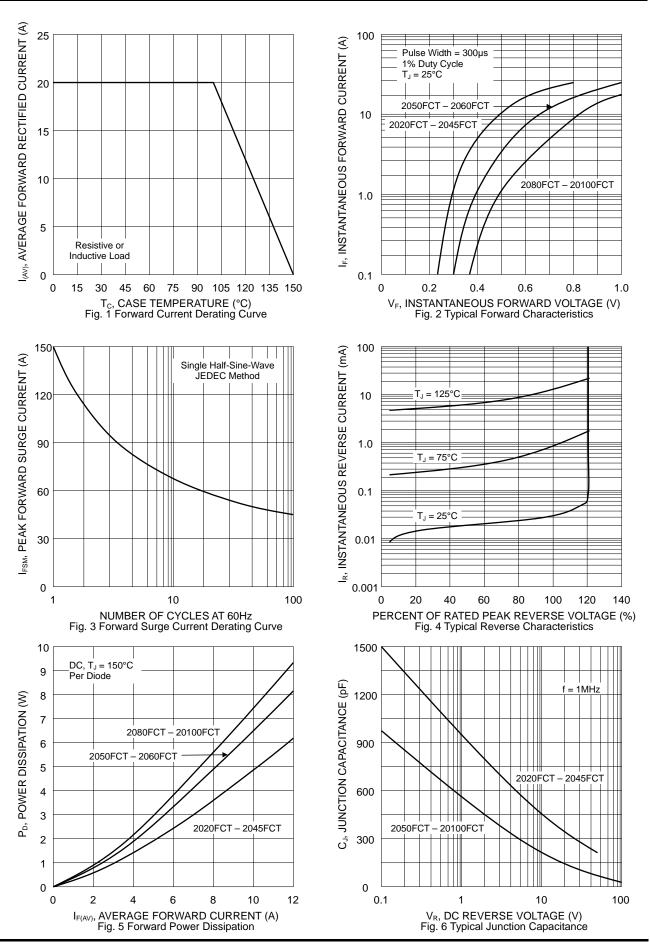
# Maximum Ratings and Electrical Characteristics @TA=25°C unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Characteristic  | Symbol             | MBR<br>2020FCT | MBR<br>2030FCT | MBR<br>2040FCT | MBR<br>2045FCT | MBR<br>2050FCT | MBR<br>2060FCT | MBR<br>2080FCT | MBR<br>20100FCT | Unit |
|---|--------------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|-----------------|------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage                                | VRRM<br>VRWM<br>VR | 20             | 30             | 40             | 45             | 50             | 60             | 80             | 100             | V    |
| RMS Reverse Voltage   | VR(RMS)            | 14             | 21             | 28             | 32             | 35             | 42             | 56             | 70              | V    |
| Average Rectified Output Current @Tc = 100°C Total Device Per Diode   | lo                 | 20<br>10       |                |                |                |                |                |                |                 | Α    |
| Non-Repetitive Peak Forward Surge Current<br>8.3ms Single Half Sine-Wave Superimposed<br>on Rated Load (JEDEC Method) | IFSM               | 150            |                |                |                |                |                |                | Α               |      |
| Forward Voltage $@I_F = 10A, T_J = 25^{\circ}C$ per diode $@I_F = 10A, T_J = 125^{\circ}C$                            | VFM                | 0.55<br>0.50   |                |                |                |                | -              | 85<br>75       | V               |      |
| Peak Reverse Current $@T_J = 25^{\circ}C$<br>At Rated DC Blocking Voltage $@T_J = 100^{\circ}C$                       | lгм                | 0.5<br>20      |                |                |                |                |                | mA             |                 |      |
| Typical Junction Capacitance (Note 1)   | Сл                 | 650 350        |                |                |                |                | pF             |                |                 |      |
| Thermal Resistance Junction to Ambient per diode<br>Thermal Resistance Junction to Case per diode                     | R JA<br>R JC       | 62<br>4.0      |                |                |                |                |                |                | °C/W            |      |
| RMS Isolation Voltage, t = 1 min  | Viso               | 1500           |                |                |                |                |                | ٧              |                 |      |
| Operating and Storage Temperature Range   | TJ, TSTG           | -55 to +150    |                |                |                |                |                | °C             |                 |      |

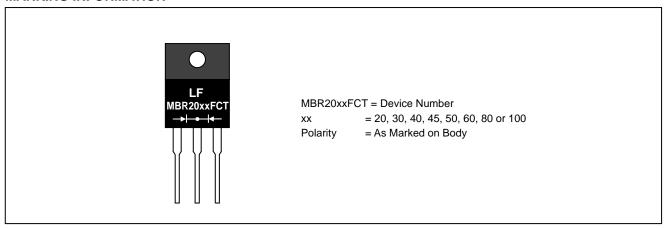
Note: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

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## **MARKING INFORMATION**



## **PACKAGING INFORMATION**

#### **BULK**

| Tube Size      | Quantity | Inner Box Size | Quantity | Carton Size     | Quantity | Approx. Gross Weight (KG) |
|----------------|----------|----------------|----------|-----------------|----------|---------------------------|
| L x W x H (mm) | (PCS)    | L x W x H (mm) | (PCS)    | L x W x H (mm)  | (PCS)    |                           |
| 525 x 31 x 6   | 50       | 558 x 150 x 40 | 1,000    | 570 x 235 x 170 | 5,000    | 11.85                     |

### RECOMMENDED SCREW MOUNTING ARRANGEMENT

The full molded plastic package affords a major reduction of hardware as compared to a standard TO-220 package. However, precautions should be made in mounting procedure.

A conical washer should be used to apply proper force to the device. Screw should not be tightened with any type of air-forced torque or equipment that may cause crack on device package.

A layer of thermal grease or thermal pad in the interface will be considerably helpful for heat dissipation.

